

# DC-6.0 GHz InGaP HBT MMIC Matched Gain Block Amplifier

## Features

- ✕ 34.0 dBm Output IP3 @ 850 MHz
- ✕ 4.5 dB Noise Figure @ 850 MHz
- ✕ 19.0 dB Gain @ 850 MHz
- ✕ 18.8 dBm P1dB @ 850 MHz
- ✕ Low Performance Variation Over Temperature
- ✕ 100% DC On-Wafer Testing
- ✕ ESD Protection on All Die: >1000V HBM
- ✕ Low Thermal Resistance: <90°C/Watt

## Description

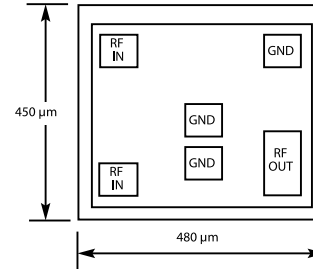
The CGB7007-BD is a Darlington Configured, high dynamic range, utility gain block amplifier. Designed for applications operating within the DC to 6.0 GHz frequency range, Mimix's broadband, cascadable, gain block amplifiers are ideal solutions for transmit, receive and IF applications.

These MMIC amplifiers are available in bare die form. Mimix's InGaP HBT technology and an industry low thermal resistance offers a thermally robust and reliable gain block solution.

The InGaP HBT die have extra pads to enable thorough DC testing. This unique test capability and the inclusion of ESD protection on all die, significantly enhances the quality, reliability and ruggedness of these products.

With a single bypass capacitor, optional RF choke and two DC blocking capacitors, this gain block amplifier offers significant ease of use in a broad range of applications.

## Chip Layout



## Absolute Maximum Ratings

Max Device Voltage	+6.0 V
Max Device Current	120 mA
Max Device Dissipated Power	0.58 W
RF Input Power	+17 dBm
Storage Temperature	-55°C to 150°C
Junction Temperature	150°C
Operating Temperature	-40°C to +85°C
Thermal Resistance	90° C/W
ESD (HBM)	1000 V

Operation of this device above any of these parameters may cause permanent damage.

## Applications

- ✕ PA Driver Amp, IF Amp, LO Buffer Amp
- ✕ Cellular, PCS, GSM, UMTS
- ✕ Wireless Data and SATCOM
- ✕ Transmit and Receive Functions
- ✕ CATV

## Typical Performance

Parameter	Temperature (°C)	850 MHz			1950 MHz			2400 MHz			3500 MHz			Units
		Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
Small Signal Gain	+25	17.8	19.0	20.2	15.8	17.0	18.2	15.0	16.2	17.4		14.5		dB
	-40 to +85	17.6	19.0	20.4	15.6	17.0	18.4	14.8	16.2	17.6		14.5		dB
Output P1dB	+25	17.8	18.8		17.5	18.5		17.3	18.3			16.5		dBm
	-40 to +85	17.5	18.8		17.2	18.5		17.0	18.3			16.5		dBm
Output IP3	+25	32.5	34.0		31.3	32.8		30.5	32.0			30.0		dBm
	-40 to +85	31.5	34.0		30.8	32.8		30.0	32.0			30.0		dBm
Noise Figure	+25		4.5	5.3		4.7	5.5		4.8	5.6		5.0		dB
	-40 to +85		4.5	5.6		4.7	5.9		4.8	6.0		5.0		dB
Operating Current	+25	63	67	71	63	67	71	63	67	71		67		mA
	-40 to +85	60	67	74	60	67	74	60	67	74		67		mA
Input Return Loss	+25	16.0	21.0		12.0	17.0		9.5	14.0			14.0		dB
	-40 to +85	15.0	21.0		11.0	17.0		9.0	14.0			14.0		dB
Output Return Loss	+25	20.0	25.0		12.0	17.0		15.0	20.0			15.0		dB
	-40 to +85	19.0	25.0		11.0	17.0		14.0	20.0			15.0		dB
Pout @ -45 dBc, ACP IS-95, 9 Forward Channels	+25		12.5			13.0								dBm
	-40 to +85		12.5			13.0								dBm

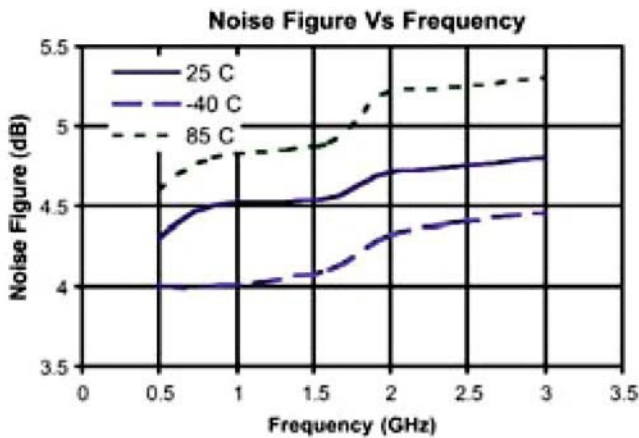
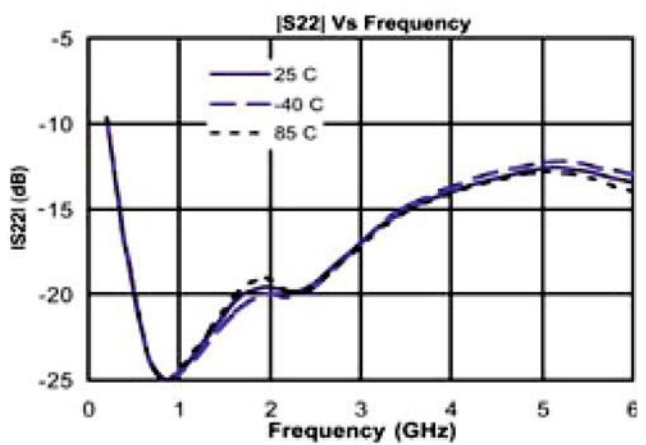
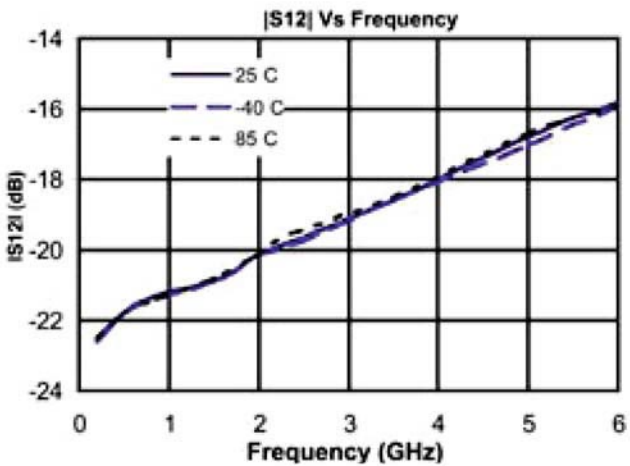
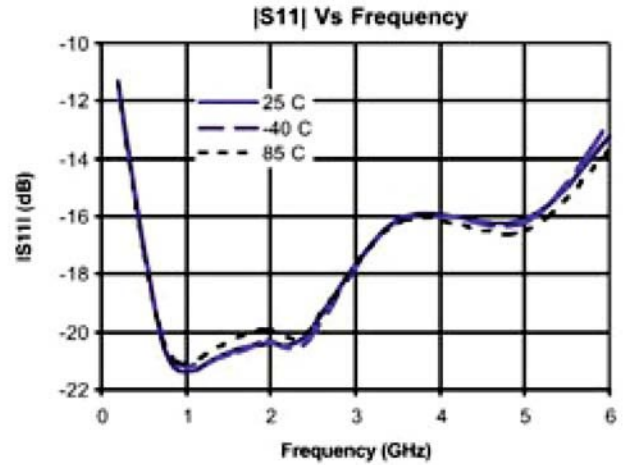
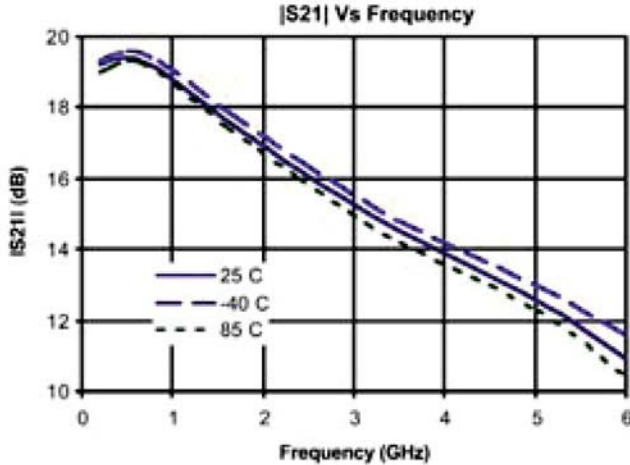
Notes: 1. Performance in Mimix eval board,  $V_s = 8V$ ,  $I_d = 67mA$  Typ.,  $R_{bias} = 47\Omega$ ,  $Z_s = Z_L = 50\Omega$ , OIP3 tone spacing = 1 MHz, Pout per tone = 3 dBm.  
2. Values reflect performance in recommended application circuit.  
3. Only on-wafer DC test is done. Devices are not tested for RF performance.

# DC-6.0 GHz InGaP HBT MMIC Matched Gain Block Amplifier

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## Typical S-Parameter and Noise Performance



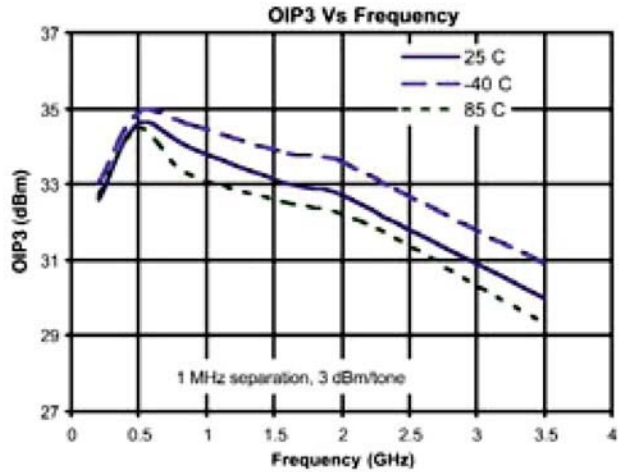
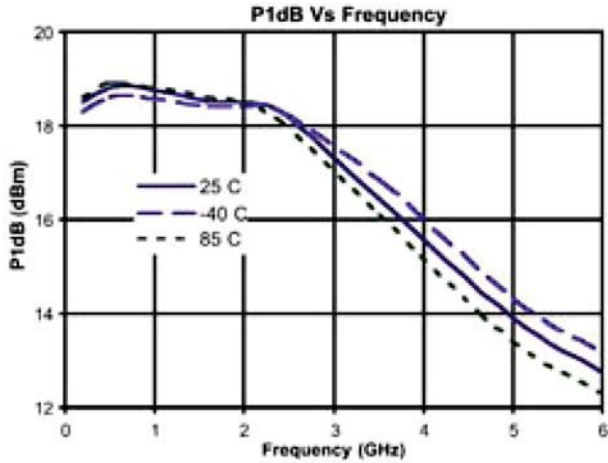
# DC-6.0 GHz InGaP HBT MMIC Matched Gain Block Amplifier



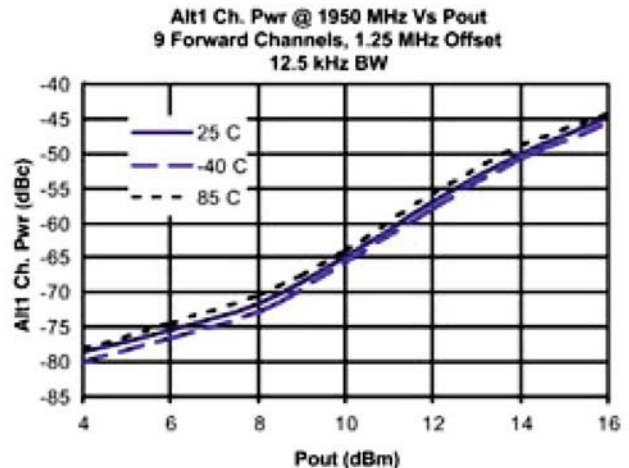
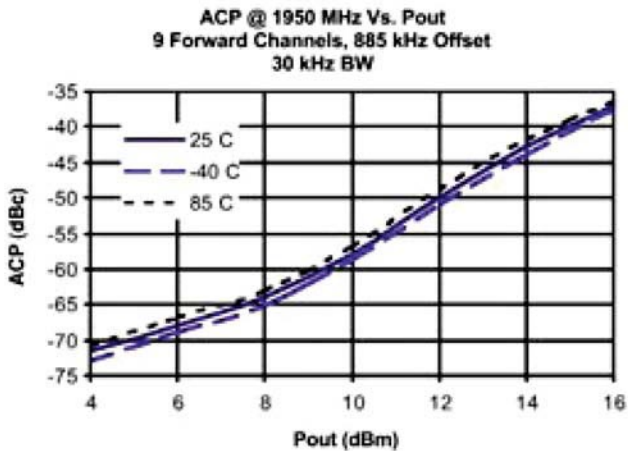
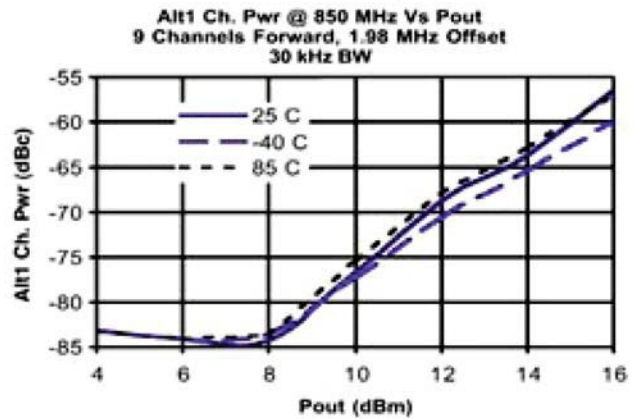
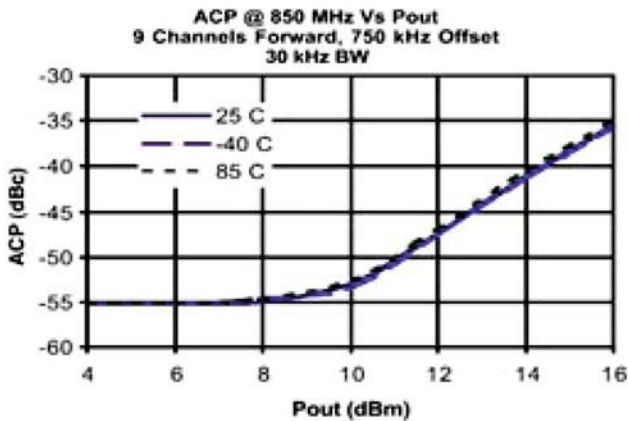
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## Typical Power and Linearity Performance



### Linearity Performance - Base Station ACP - IS-95



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## Typical Scattering Parameters (Vd = +4.95V, Icc = 66.7 mA, T = 23°C, device in a 50 ohm system)

Frequency (MHz)	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
	(Mag)	(Ang)	(Mag)	(Ang)	(Mag)	(Ang)	(Mag)	(Ang)
100	0.016	-27.0	9.84	173.9	0.079	-0.9	0.071	-13.6
200	0.019	-51.0	9.77	167.9	0.079	-1.5	0.074	-26.2
300	0.025	-64.5	9.71	162.0	0.079	-2.0	0.077	-38.7
400	0.030	-74.7	9.63	156.2	0.080	-3.1	0.081	-49.7
500	0.036	-81.7	9.53	150.5	0.080	-3.7	0.086	-59.8
600	0.042	-87.8	9.42	144.8	0.081	-4.5	0.091	-69.6
700	0.048	-93.5	9.30	139.1	0.081	-5.4	0.096	-78.6
800	0.054	-98.2	9.18	133.5	0.082	-6.1	0.102	-86.6
900	0.059	-102.0	9.04	128.0	0.083	-7.1	0.108	-94.3
1000	0.065	-106.5	8.91	122.6	0.084	-8.1	0.113	-101.7
1100	0.070	-110.2	8.76	117.2	0.085	-9.1	0.118	-108.7
1200	0.075	-113.6	8.61	111.8	0.086	-10.2	0.122	-114.9
1300	0.080	-117.0	8.45	106.6	0.088	-11.4	0.127	-121.1
1400	0.084	-120.3	8.29	101.4	0.089	-12.5	0.131	-126.8
1500	0.088	-123.1	8.14	96.3	0.090	-13.8	0.135	-132.5
1600	0.093	-126.1	7.98	91.2	0.091	-15.0	0.138	-137.8
1700	0.097	-128.9	7.82	86.3	0.093	-16.4	0.141	-142.7
1800	0.101	-131.7	7.66	81.3	0.094	-17.9	0.144	-147.9
1900	0.104	-134.3	7.51	76.5	0.096	-19.4	0.146	-152.6
2000	0.107	-136.9	7.36	71.7	0.097	-20.8	0.148	-157.6
2100	0.111	-139.7	7.21	67.0	0.099	-22.3	0.149	-162.1
2200	0.113	-142.2	7.05	62.3	0.100	-23.9	0.150	-166.6
2300	0.115	-144.8	6.91	57.7	0.102	-25.6	0.151	-171.1
2400	0.117	-147.4	6.77	53.1	0.103	-27.3	0.152	-175.5
2500	0.119	-149.9	6.63	48.6	0.105	-29.0	0.152	-180.0
2600	0.119	-152.2	6.49	44.2	0.107	-30.8	0.151	175.9
2700	0.120	-154.2	6.36	39.8	0.109	-32.5	0.150	171.9
2800	0.122	-156.7	6.24	35.5	0.110	-34.3	0.151	167.8
2900	0.123	-159.4	6.13	31.1	0.112	-36.1	0.152	163.6
3000	0.124	-161.8	6.01	26.8	0.114	-38.0	0.151	159.5
3100	0.125	-164.4	5.90	22.6	0.116	-39.9	0.152	155.3
3200	0.126	-167.1	5.80	18.3	0.118	-41.9	0.152	151.0
3300	0.127	-170.1	5.70	14.1	0.120	-44.1	0.153	146.7
3400	0.128	-173.4	5.61	9.9	0.122	-46.2	0.154	142.2
3500	0.129	-176.4	5.51	5.6	0.124	-48.3	0.155	137.7
3600	0.129	-179.5	5.41	1.4	0.126	-50.5	0.155	133.4
3700	0.129	177.1	5.32	-2.7	0.127	-52.7	0.156	128.7
3800	0.129	173.5	5.24	-6.9	0.129	-54.9	0.158	123.8
3900	0.129	169.4	5.15	-11.1	0.131	-57.3	0.159	119.1
4000	0.128	165.4	5.07	-15.2	0.133	-59.5	0.161	114.1
4100	0.127	161.1	4.99	-19.3	0.135	-61.9	0.163	109.1
4200	0.125	156.8	4.91	-23.5	0.137	-64.3	0.166	104.0
4300	0.123	151.8	4.84	-27.6	0.139	-66.7	0.169	98.7
4400	0.122	146.5	4.77	-31.7	0.141	-69.1	0.174	93.3
4500	0.119	140.8	4.69	-35.9	0.143	-71.7	0.178	87.9
4600	0.118	135.4	4.62	-39.9	0.145	-74.2	0.182	82.7
4700	0.115	129.5	4.56	-44.1	0.146	-76.7	0.187	77.6
4800	0.113	122.7	4.49	-48.2	0.148	-79.3	0.194	72.4
4900	0.112	115.2	4.43	-52.3	0.150	-82.0	0.201	67.2
5000	0.112	107.3	4.36	-56.5	0.152	-84.6	0.209	61.8

Continues Next Page. S-Parameter Data Files are available online at: [www.mimixbroadband.com](http://www.mimixbroadband.com)

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# DC-6.0 GHz InGaP HBT MMIC Matched Gain Block Amplifier



April 2007 - Rev 03-Apr-07

**CGB7007-BD**  
**XRoHS**

## Typical Scattering Parameters (Vd = +4.95V, Icc = 66.7 mA, T = 23°C, device in a 50 ohm system)

Frequency (MHz)	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
	(Mag)	(Ang)	(Mag)	(Ang)	(Mag)	(Ang)	(Mag)	(Ang)
5100	0.112	99.7	4.30	-60.6	0.153	-87.4	0.216	56.6
5200	0.113	92.0	4.24	-64.7	0.155	-90.0	0.223	51.7
5300	0.114	83.8	4.18	-68.9	0.156	-92.8	0.232	46.9
5400	0.117	74.5	4.12	-73.1	0.158	-95.6	0.242	41.8
5500	0.122	65.8	4.06	-77.3	0.159	-98.4	0.252	36.6
5600	0.128	57.6	4.00	-81.4	0.161	-101.3	0.262	31.8
5700	0.135	49.7	3.94	-85.7	0.162	-104.2	0.273	27.2
5800	0.142	41.7	3.88	-89.9	0.163	-107.1	0.284	22.3
5900	0.151	33.5	3.82	-94.2	0.164	-110.2	0.297	17.3
6000	0.163	25.9	3.76	-98.5	0.165	-113.2	0.310	12.6
6100	0.176	19.1	3.70	-102.7	0.166	-116.1	0.323	8.0
6200	0.188	12.6	3.63	-107.1	0.166	-119.2	0.337	3.5
6300	0.201	6.2	3.57	-111.4	0.167	-122.3	0.350	-0.9
6400	0.215	-0.3	3.51	-115.7	0.167	-125.4	0.364	-5.4
6500	0.230	-6.4	3.44	-120.0	0.167	-128.6	0.378	-9.8
6600	0.247	-11.9	3.37	-124.3	0.167	-131.7	0.392	-14.1
6700	0.262	-17.0	3.31	-128.6	0.167	-134.7	0.406	-18.3
6800	0.277	-22.1	3.24	-132.9	0.166	-137.8	0.419	-22.3
6900	0.292	-27.3	3.17	-137.2	0.166	-140.9	0.432	-26.3
7000	0.308	-32.6	3.10	-141.5	0.165	-144.1	0.446	-30.4
7100	0.324	-37.5	3.02	-145.8	0.164	-147.2	0.458	-34.3
7200	0.341	-42.0	2.95	-150.0	0.163	-150.3	0.471	-38.4
7300	0.356	-46.4	2.88	-154.2	0.161	-153.4	0.481	-42.2
7400	0.369	-51.0	2.81	-158.5	0.160	-156.4	0.492	-45.9
7500	0.383	-55.7	2.73	-162.7	0.159	-159.6	0.502	-49.8
7600	0.399	-60.1	2.66	-166.8	0.157	-162.6	0.513	-53.6
7700	0.414	-64.2	2.59	-170.9	0.155	-165.5	0.523	-57.3
7800	0.427	-68.2	2.51	-174.9	0.153	-168.4	0.531	-60.9
7900	0.438	-72.1	2.44	-179.0	0.151	-171.3	0.539	-64.4
8000	0.449	-76.3	2.37	-177.0	0.148	-174.1	0.547	-67.7
8100	0.461	-80.4	2.30	-173.1	0.146	-176.9	0.555	-71.0
8200	0.473	-84.1	2.23	-169.3	0.144	-179.6	0.564	-74.3
8300	0.483	-87.5	2.16	-165.5	0.142	-177.8	0.571	-77.4
8400	0.490	-91.0	2.10	-161.9	0.140	-175.2	0.575	-80.4
8500	0.496	-94.6	2.04	-158.1	0.137	-172.7	0.580	-83.3
8600	0.503	-98.4	1.98	-154.4	0.135	-170.0	0.585	-86.3
8700	0.511	-101.9	1.92	-150.8	0.133	-167.5	0.589	-89.2
8800	0.517	-105.1	1.86	-147.2	0.130	-165.2	0.593	-92.0
8900	0.520	-108.2	1.80	-143.7	0.128	-163.0	0.595	-94.5
9000	0.521	-111.5	1.75	-140.2	0.126	-160.5	0.597	-97.2
9100	0.522	-115.0	1.70	-136.7	0.124	-158.3	0.598	-99.8
9200	0.526	-118.5	1.65	-133.2	0.122	-155.8	0.600	-102.3
9300	0.528	-121.6	1.59	-129.7	0.120	-153.5	0.600	-105.0
9400	0.529	-124.5	1.55	-126.3	0.118	-151.4	0.600	-107.6
9500	0.527	-127.6	1.50	-122.9	0.116	-149.3	0.598	-109.9
9600	0.524	-130.9	1.46	-119.5	0.114	-147.1	0.597	-112.3
9700	0.523	-134.3	1.41	-116.1	0.112	-144.9	0.598	-114.6
9800	0.523	-137.4	1.37	-112.8	0.110	-143.0	0.599	-116.9
9900	0.522	-140.1	1.33	-109.7	0.108	-141.0	0.598	-119.2
10000	0.517	-142.8	1.29	-106.4	0.106	-139.1	0.598	-121.3

S-Parameter Data Files are available online at: [www.mimixbroadband.com](http://www.mimixbroadband.com)

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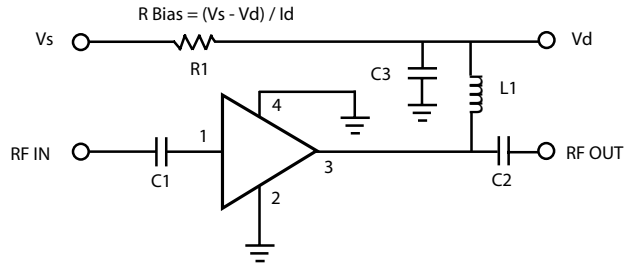
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## Application Circuit

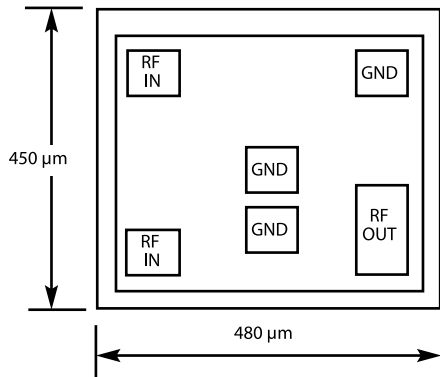
Note: This schematic represents the topology of the application circuit recommended by Mimix.

Recommended Bias Resistor Values for ID = 63 mA				
Supply Voltage (Vs)	7V	8V	10V	12V
Rbias (1/4W)	32 Ω	47Ω	—	—
Rbias (1/2W)	—	—	82Ω	110 Ω

Note: Rbias provides DC bias stability over temperature.



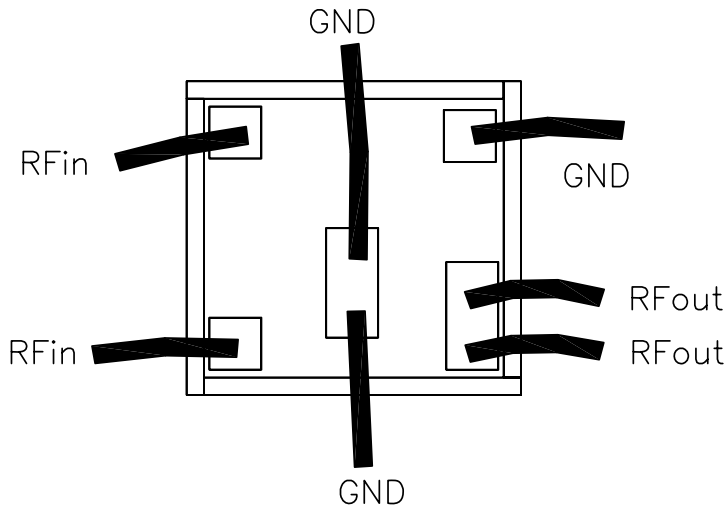
## Physical Dimensions



Notes:  
RF OUT bonding pad is 75 μm x 155 μm.  
All other pads are 75 μm x 75 μm.

Ref Designator	Value
C1, C2	1000 pF
C3	1.0 μF
L1	56 nH
R 1	$R_{Bias} = (V_s - V_d) / I_d$

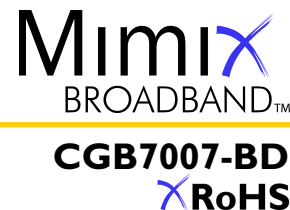
## Bonding Configuration



**Caution: ESD Sensitive**  
Appropriate precautions in handling, packaging  
and testing devices must be observed.



# DC-6.0 GHz InGaP HBT MMIC Matched Gain Block Amplifier



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## Handling and Assembly Information

**CAUTION!** - Mimix Broadband MMIC Products contain gallium arsenide (GaAs) which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- *Do not ingest.*
- *Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.*
- *Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.*

**Life Support Policy** - Mimix Broadband's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President and General Counsel of Mimix Broadband. As used herein: (1) Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user. (2) A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

**ESD** - Gallium Arsenide (GaAs) devices are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic containers, which should be opened in cleanroom conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickups or, with care, sharp tweezers.

**Die Attachment** - GaAs Products from Mimix Broadband are 0.100 mm (0.004") thick. Microstrip substrates should be brought as close to the die as possible. The mounting surface should be clean and flat. If using conductive epoxy, recommended epoxies are Tanaka TS3332LD, Die Mat DM6030HK or DM6030HK-Pt cured in a nitrogen atmosphere per manufacturer's cure schedule. Apply epoxy sparingly to avoid getting any on to the top surface of the die. An epoxy fillet should be visible around the total die periphery. For additional information please see the Mimix "Epoxy Specifications for Bare Die" application note.

**Wire Bonding** - Windows in the surface passivation above the bond pads are provided to allow wire bonding to the die's gold bond pads. The recommended wire bonding procedure uses Gold 0.025 mm (0.001") diameter ball bonds. Aluminum wire should be avoided. Thermo-compression bonding is recommended though thermosonic bonding may be used providing the ultrasonic content of the bond is minimized. Bond force, time and ultrasonics are all critical parameters. Bonds should be made from the bond pads on the die to the package or substrate. All bonds should be as short as possible.

Part Number for Ordering	Description
CGB7007-BD-000V	RoHS compliant die packed in vacuum release gel paks